506541893 03/08/2021

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6588671

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SHANKAR NATARAJAN	02/01/2021
SURESH NAGARAJAN	03/01/2021
ALIASGAR S. MADRASWALA	03/01/2021
YIHUA ZHANG	02/04/2021

RECEIVING PARTY DATA

Name:	INTEL CORPORATION
Street Address:	2200 MISSION COLLEGE BLVD
City:	SANTA CLARA
State/Country:	CALIFORNIA
Postal Code:	95054

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17133459

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 503-730-8937

Email: annie@compassiplaw.com, bob@compassiplaw.com

Correspondent Name: VINCENT H. ANDERSON

Address Line 1: 4804 NW BETHANY BLVD, STE. I-2 #237

Address Line 4: PORTLAND, OREGON 97229

ATTORNEY DOCKET NUMBER:	AD0611-US
NAME OF SUBMITTER:	ANNIE PEARSON
SIGNATURE:	/Annie Pearson/
DATE SIGNED:	03/08/2021

Total Attachments: 8

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ASSIGNMENT

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we, the ordersigned inventor(s):

SHANKAR NATARAJAN; SURESH NAGARAJAN; ALJASGAR S. MADRASWALA; YIHUA ZHANG

hereby sell, assign, and transfer to:

INTEL CORPORATION

a corporation of Delaware, having a principal place of business at 2200 Mission College Boulevard, Santa Clara, California, 95054 USA ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all other countries, in and to any and all inventions and improvements that are disclosed in the application for the patent entitled:

UTILIZING NAND BUFFER FOR DRAM-LESS MULTILEVEL CELL PROGRAMMING

(I hereby authorize and request any attorney having appropriate authority from the assignce to insert on the designated lines below, the filing date and application number of said application when known.)

which was filed on	December 23.	2020		
US COUNTRY or Inte		Application Number	17/133,439	 and

which has been executed by the undersigned prior hereto or concurrently herewith on the date(s) indicated below,

and in and to said application and all Additional Applications, and all other patent applications that have been or shall be filed in the United States and all other countries and international filing offices on any of said inventions and improvements; and in and to all original and reissued patents that have been or shall be issued in the United States and all other countries and international filing offices on said inventions and improvements; and in and to all rights of priority resulting from the filing of said applications; as used herein "Additional Applications" includes but is not limited to design, attifity, utility model, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and national phase applications on said inventions and improvements;

and agree that said Assignee may apply for and receive a patent or patents for said inventions and improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all Additional Applications, and all other patent applications on any and all said inventions and improvements; execute all rightful ouths, assignments, powers of attorney, and other papers; communicate to said Assignee, its successors, assigns, and legal representatives all facts known to the undersigned relating to said inventions and improvements and the history thereof; and generally assist said Assignee, its successors, assigns, or legal representatives in securing and

maintaining proper patent protection for said inventions and improvements and for vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and logal representatives; and

covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, ficense, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

	2/1/2021
SHANKAR NATARAJAN	Date signed
SURESH NAGARAJAN	Date signed
ALIASGAR S. MADRASWALA	Date signed
YHUA ZHANG	Date signed

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which was filed on	December 23,	2020		
US COUNTRY or Inte	reational Office	Application Number	_17/133.459	and

which has been executed by the undersigned prior hereto or concurrently herewith on the date(s) indicated below,

and in and to said application and all Additional Applications, and all other patent applications that have been or shall be filled in the United States and all other countries and international filing offices on any of said inventions and improvements; and in and to all original and reissued patents that have been or shall be issued in the United States and all other countries and international filing offices on said inventions and improvements; and in and to all rights of priority resulting from the filing of said applications; as used herein "Additional Applications" includes but is not limited to design, utility, utility model, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and national phase applications on said inventions and improvements;

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Page 1 of 2

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SHANKAR NATARAJAN	Date signed
Juny-	03/01/2021
SURESH NAGARAJAN	Date signed
	*
ALIASGAR S. MADRASWALA	Date signed
YIHUA ZHANG	Date signed

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US		Application Number	17/133,459	and
COUNTRY or Inter	rnational Office	* *		

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SHANKAR NATARAJAN	Date signed
SURESH NAGARAJAN	Date signed
94 A 2	03/01/202
ÁLIASGÁR S. MADRASWALA	Date signed
YIHUA ZHANG	Date signed

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SHANKAR NATARAJAN	Date signed
SURESH NAGARAJAN	Date signed
ALIASGAR S. MADRASWALA	Date signed
Vihne Than	2/4/2021
YİHUA ZHANG	Date signed

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